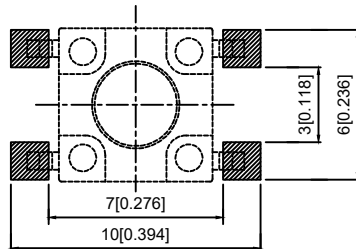
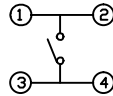


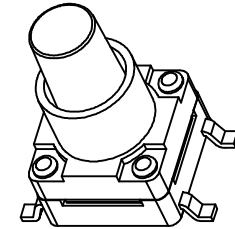
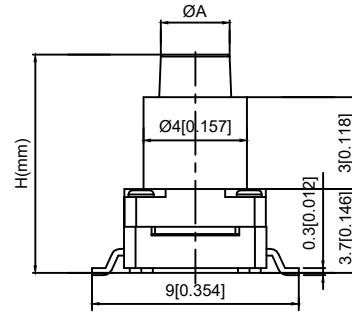
Code-x	H
A	4.3
B	4.5
C	5.0
D	5.5
E	6.0
F	6.5
G	7.0
H	7.5
I	8.0
J	8.5
K	9.0



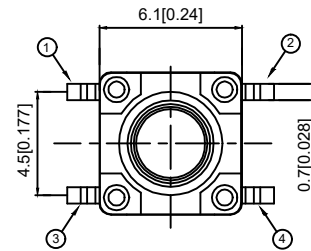
PCB LAYOUT PLAN



CIRCUIT DIAGRAM



Code-X	H
L	9.5
M	10.0
N	10.5
O	11.0
P	11.5
Q	12
R	12.5
S	13.0
T	13.5
U	14.0
V	15.0
W	15.5
X	16
Y	16.5
Z	17
18	18
19	19



SPECIFICATION

Contact Rating: 50mA, 12V DC
 Contact Resistance: 100mΩ max
 Insulation Resistance: 100mΩ min. 500V DC
 Dielectric Strength: 250V AC/1minute
 Travel: 0.25mm
 Operating Temp: -30℃~+85℃
 Storage Temp: -30℃~+80℃

PAPT NO	TS-FS66T-X-X
Operating Force	A:100gf B:160gf C:260gf
Height	Code-x

ITEM	PAPT NAMF	TER,NO	QTY	MATERIAL	FINISHING	REMARK
⑤	Terminal	—	4	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	PPA		—
②	Cover	—	1	PPA		—
①	Keystake	—	1	PPA		—

MARK	DESCRIPTION	DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES	DSND	DATE	SCALE: N/A	MODEL TYPE:		
ΔX					units: mm	DWN	DATE	VIEW:	TACT SWITCH		
ΔX					tolerance: X.X ±0.2mm	CHKD	DATE	UNIT: mm/in	PART NO.:		
ΔX					X.XX ±0.1mm	APPD	DATE	SIZE: A4	DWG NO.:		
MARK					X.XXX ±0.05mm				TS-CB1157-X-X		
REVISIONS						DONG GUAN XI BANG ELECTRONIC CO., LTD			WEIGHT	SHEET	REVISION
www.alpsr.com www.gdxjdz.com www.xbswitch.com									1.0g	1/1	A0